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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	80C51
Core Size	8-Bit
Speed	40/20MHz
Connectivity	UART/USART
Peripherals	POR
Number of I/O	32
Program Memory Size	-
Program Memory Type	ROMIess
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-VQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/atmel/at80c32x2-rltum

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SFR Mapping

The Special Function Registers (SFRs) of the TS80C52X2 fall into the following categories:

- C51 core registers: ACC, B, DPH, DPL, PSW, SP, AUXR1
- I/O port registers: P0, P1, P2, P3
- Timer registers: T2CON, T2MOD, TCON, TH0, TH1, TH2, TMOD, TL0, TL1, TL2, RCAP2L, RCAP2H
- Serial I/O port registers: SADDR, SADEN, SBUF, SCON
- Power and clock control registers: PCON
- Interrupt system registers: IE, IP, IPH
- Others: AUXR, CKCON



Pin Configuration



*NIC: No Internal Connection



Application

Software can take advantage of the additional data pointers to both increase speed and reduce code size, for example, block operations (copy, compare, search ...) are well served by using one data pointer as a 'source' pointer and the other one as a "destination" pointer.

ASSEMBLY LANGUAGE

; Block move using dual data pointers ; Destroys DPTR0, DPTR1, A and PSW ; note: DPS exits opposite of entry state ; unless an extra INC AUXR1 is added 00A2 AUXR1 EQU 0A2H 0000 909000MOV DPTR,#SOURCE ; address of SOURCE 0003 05A2 INC AUXR1 ; switch data pointers 0005 90A000 MOV DPTR,#DEST ; address of DEST 0008 LOOP: 0008 05A2 INC AUXR1 ; switch data pointers 000A E0 MOVX A, atDPTR ; get a byte from SOURCE 000B A3 INC DPTR ; increment SOURCE address 000C 05A2 INC AUXR1 ; switch data pointers 000E F0 MOVX atDPTR, A ; write the byte to DEST 000F A3 INC DPTR ; increment DEST address 0010 70F6JNZ LOOP ; check for 0 terminator 0012 05A2 INC AUXR1 ; (optional) restore DPS

INC is a short (2 bytes) and fast (12 clocks) way to manipulate the DPS bit in the AUXR1 SFR. However, note that the INC instruction does not directly force the DPS bit to a particular state, but simply toggles it. In simple routines, such as the block move example, only the fact that DPS is toggled in the proper sequence matters, not its actual value. In other words, the block move routine works the same whether DPS is '0' or '1' on entry. Observe that without the last instruction (INC AUXR1), the routine will exit with DPS in the opposite state.







Programmable Clock-output

In the clock-out mode, timer 2 operates as a 50%-duty-cycle, programmable clock generator (See Figure 5). The input clock increments TL2 at frequency F_{OSC}/2. The timer repeatedly counts to overflow from a loaded value. At overflow, the contents of RCAP2H and RCAP2L registers are loaded into TH2 and TL2. In this mode, timer 2 overflows do not generate interrupts. The formula gives the clock-out frequency as a function of the system oscillator frequency and the value in the RCAP2H and RCAP2L registers :

$$Clock - OutFrequency = \frac{F_{osc}}{4 \times (65536 - RCAP2H/RCAP2L)}$$

For a 16 MHz system clock, timer 2 has a programmable frequency range of 61 Hz $(F_{OSC}/2^{16})$ to 4 MHz $(F_{OSC}/4)$. The generated clock signal is brought out to T2 pin (P1.0).

Timer 2 is programmed for the clock-out mode as follows:

- Set T2OE bit in T2MOD register.
- Clear C/T2 bit in T2CON register.
- Determine the 16-bit reload value from the formula and enter it in RCAP2H/RCAP2L registers.
- Enter a 16-bit initial value in timer registers TH2/TL2. It can be the same as the reload value or a different one depending on the application.
- To start the timer, set TR2 run control bit in T2CON register.

It is possible to use timer 2 as a baud rate generator and a clock generator simultaneously. For this configuration, the baud rates and clock frequencies are not independent since both functions use the values in the RCAP2H and RCAP2L registers.



TS80C52X2 Serial I/O
PortThe serial I/O port in the TS80C52X2 is compatible with the serial I/O port in the 80C52.
It provides both synchronous and asynchronous communication modes. It operates as
an Universal Asynchronous Receiver and Transmitter (UART) in three full-duplex
modes (Modes 1, 2 and 3). Asynchronous transmission and reception can occur simul-
taneously and at different baud rates
Serial I/O port includes the following enhancements:
 Framing error detectionAutomatic address recognitionFraming bit error detection is provided for the three asynchronous modes (modes 1, 2
and 3). To enable the framing bit error detection feature, set SMOD0 bit in PCON regis-
ter (See Figure 6).

Figure 6. Framing Error Block Diagram



When this feature is enabled, the receiver checks each incoming data frame for a valid stop bit. An invalid stop bit may result from noise on the serial lines or from simultaneous transmission by two CPUs. If a valid stop bit is not found, the Framing Error bit (FE) in SCON register (See Table 9.) bit is set.

Software may examine FE bit after each reception to check for data errors. Once set, only software or a reset can clear FE bit. Subsequently received frames with valid stop bits cannot clear FE bit. When FE feature is enabled, RI rises on stop bit instead of the last data bit (See Figure 7. and Figure 8.).

Figure 7. UART Timings in Mode 1





Table 10. PCON RegisterPCON - Power Control Register (87h)

7	6	5	4	3	2	1	0					
SMOD1	SMOD0	-	POF	GF1	GF0	PD	IDL					
Bit Number	Bit Mnemonic	Descriptio	Description									
7	SMOD1	Serial port Set to sele	Mode bit 1 ct double bau	id rate in mode	e 1, 2 or 3.							
6	SMOD0	Serial port Clear to sel Set to to se	Serial port Mode bit 0 Clear to select SM0 bit in SCON register. Set to to select FE bit in SCON register.									
5	-	Reserved The value r	Reserved The value read from this bit is indeterminate. Do not set this bit.									
4	POF	Power-off Clear to rec Set by hard by software	Power-off Flag Clear to recognize next reset type. Set by hardware when VCC rises from 0 to its nominal voltage. Can also be set by software.									
3	GF1	General pu Cleared by Set by user	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.									
2	GF0	General pu Cleared by Set by user	General purpose Flag Cleared by user for general purpose usage. Set by user for general purpose usage.									
1	PD	Power-dow Cleared by Set to enter	vn mode bit hardware wh r power-down	en reset occur mode.	S.							
0	IDL	Idle mode Clear by ha Set to enter	bit Irdware when r idle mode.	interrupt or re	set occurs.							

Reset Value = 00X1 0000b Not bit addressable

Power-off flag reset value will be 1 only after a power on (cold reset). A warm reset doesn't affect the value of this bit.





Interrupt System

The TS80C52X2 has a total of 6 interrupt vectors: two external interrupts (INT0 and INT1), three timer interrupts (timers 0, 1 and 2) and the serial port interrupt. These interrupts are shown in Figure 9.

Figure 9. Interrupt Control System



Each of the interrupt sources can be individually enabled or disabled by setting or clearing a bit in the Interrupt Enable register (See Table 12.). This register also contains a global disable bit, which must be cleared to disable all interrupts at once.

Each interrupt source can also be individually programmed to one out of four priority levels by setting or clearing a bit in the Interrupt Priority register (See Table 13.) and in the Interrupt Priority High register (See Table 14.). shows the bit values and priority levels associated with each combination.

Table 11. Priority Level Bit Values	

IPH.x	IP.x	Interrupt Level Priority
0	0	0 (Lowest)
0	1	1
1	0	2
1	1	3 (Highest)

A low-priority interrupt can be interrupted by a high priority interrupt, but not by another low-priority interrupt. A high-priority interrupt can't be interrupted by any other interrupt source.

If two interrupt requests of different priority levels are received simultaneously, the request of higher priority level is serviced. If interrupt requests of the same priority level

are received simultaneously, an internal polling sequence determines which request is serviced. Thus within each priority level there is a second priority structure determined by the polling sequence.

Table 12. IE Register

IE - Interrupt Enable Register (A8h)

7	6	5	4	3	2	1	0					
EA	-	ET2	ES	ET1	EX1	ET0	EX0					
Bit Number	Bit Mnemonic	Description	Description									
7	EA	Enable All int Clear to disab Set to enable If EA=1, each clearing its ow	Enable All interrupt bit Clear to disable all interrupts. Set to enable all interrupts. f EA=1, each interrupt source is individually enabled or disabled by setting or clearing its own interrupt enable bit.									
6	-	Reserved The value read	d from this bit	is indetermina	ate. Do not se	t this bit.						
5	ET2	Timer 2 overf Clear to disab Set to enable	Timer 2 overflow interrupt Enable bit Clear to disable timer 2 overflow interrupt. Set to enable timer 2 overflow interrupt.									
4	ES	Serial port Er Clear to disab Set to enable	n able bit le serial port i serial port inte	nterrupt. errupt.								
3	ET1	Timer 1 overf Clear to disab Set to enable	low interrup le timer 1 ove timer 1 overfle	t Enable bit rflow interrupt ow interrupt.								
2	EX1	External inter Clear to disab Set to enable	rupt 1 Enable le external int external inter	e bit errupt 1. rupt 1.								
1	ET0	Timer 0 overf Clear to disab Set to enable	low interrup le timer 0 ove timer 0 overfle	t Enable bit rflow interrupt ow interrupt.								
0	EX0	External inter Clear to disab Set to enable	rupt 0 Enable le external int external inter	e bit errupt 0. rupt 0.								

Reset Value = 0X00 0000b Bit addressable





Table 13. IP RegisterIP - Interrupt Priority Register (B8h)

7	6	5	4	3	2	1	0					
-	-	PT2	PS	PT1	PX1	PT0	PX0					
Bit Number	Bit Mnemonic	Descriptio	Description									
7	-	Reserved The value	Reserved The value read from this bit is indeterminate. Do not set this bit.									
6	-	Reserved The value	Reserved The value read from this bit is indeterminate. Do not set this bit.									
5	PT2	Timer 2 ov Refer to PT	Timer 2 overflow interrupt Priority bit Refer to PT2H for priority level.									
4	PS	Serial port	t Priority bit SH for priority	level.								
3	PT1	Timer 1 ov Refer to PT	rerflow interr	r upt Priority b y level.	bit							
2	PX1	External in Refer to P	nterrupt 1 Pri	i ority bit y level.								
1	PT0	Timer 0 ov Refer to PT	erflow interr	r upt Priority b y level.	pit							
0	PX0	External in Refer to P	nterrupt 0 Pri (0H for priorit	i ority bit y level.								

Reset Value = XX00 0000b Bit addressable

Exit from power-down by reset redefines all the SFRs, exit from power-down by external interrupt does no affect the SFRs.

Exit from power-down by either reset or external interrupt does not affect the internal RAM content.

Note: If idle mode is activated with power-down mode (IDL and PD bits set), the exit sequence is unchanged, when execution is vectored to interrupt, PD and IDL bits are cleared and idle mode is not entered.

Mode	Program Memory	ALE	PSEN	PORT0	PORT1	PORT2	PORT3
Idle	Internal	1	1	Port Data ⁽¹⁾	Port Data	Port Data	Port Data
Idle	External	1	1	Floating	Port Data	Address	Port Data
Power Down	Internal	0	0	Port Data ⁽¹⁾	Port Data ⁽¹⁾ Port Data Port Dat		Port Data
Power Down	External	0	0	Floating	Port Data	Port Data	Port Data

Table 15. The State of Ports During Idle and Power-down Modes

Note: 1. Port 0 can force a "zero" level. A "one" will leave port floating.





Reduced EMI Mode

The ALE signal is used to demultiplex address and data buses on port 0 when used with external program or data memory. Nevertheless, during internal code execution, ALE signal is still generated. In order to reduce EMI, ALE signal can be disabled by setting AO bit.

The AO bit is located in AUXR register at bit location 0. As soon as AO is set, ALE is no longer output but remains active during MOVX and MOVC instructions and external fetches. During ALE disabling, ALE pin is weakly pulled high.

Table 18. AUXR Register

AUXR - Auxiliary Register (8Eh)

7	6	5	4	3	2	1	0					
-	-	-	-	-	-	-	AO					
Bit Number	Bit Mnemonic	Description	Description									
7	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.									
6	-	Reserved The value rea	eserved he value read from this bit is indeterminate. Do not set this bit.									
5	-	Reserved The value rea	Reserved The value read from this bit is indeterminate. Do not set this bit.									
4	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.						
3	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.						
2	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.						
1	-	Reserved The value rea	ad from this b	it is indetermi	nate. Do not s	et this bit.						
0	AO	ALE Output Clear to resto Set to disable	bit pre ALE opera e ALE operati	ation during in on during inte	ternal fetches rnal fetches.							

Reset Value = XXXX XXX0b Not bit addressable

TS80C52X2

ROM Structure The T

The TS80C52X2 ROM memory is divided in three different arrays:

- the code array:8 Kbytes.
- the encryption array:64 bytes.
- the signature array:4 bytes.

ROM Lock System The program Lock system, when programmed, protects the on-chip program against software piracy.

Encryption Array Within the ROM array are 64 bytes of encryption array that are initially unprogrammed (all FF's). Every time a byte is addressed during program verify, 6 address lines are used to select a byte of the encryption array. This byte is then exclusive-NOR'ed (XNOR) with the code byte, creating an encrypted verify byte. The algorithm, with the encryption array in the unprogrammed state, will return the code in its original, unmodified form.

When using the encryption array, one important factor needs to be considered. If a byte has the value FFh, verifying the byte will produce the encryption byte value. If a large block (>64 bytes) of code is left unprogrammed, a verification routine will display the content of the encryption array. For this reason all the unused code bytes should be programmed with random values. This will ensure program protection.

Program Lock BitsThe lock bits when programmed according to Table 19. will provide different level of pro-
tection for the on-chip code and data.

Table 19.	Program	Lock bits	
Pr	ogram Lock	Bits	

Pi	rogram L	ock Bits		
Security level	LB1	LB2	LB3	Protection Description
1	U	U	U	No program lock features enabled. Code verify will still be encrypted by the encryption array if programmed. MOVC instruction executed from external program memory returns non encrypted data.
2	Ρ	U	U	MOVC instruction executed from external program memory are disabled from fetching code bytes from internal memory, EA is sampled and latched on reset.

U: unprogrammed P: programmed

Signature bytes

The TS80C52X2 contains 4 factory programmed signatures bytes. To read these bytes, perform the process described in section 9.

Verify Algorithm

Refer to Section "Verify Algorithm".





EPROM Structure The TS87C52X2 is divided in two different arrays:

- the code array: 8 Kbytes
- the encryption array: 64 bytes

In addition a third non programmable array is implemented:

the signature array: 4 bytes

EPROM Lock System The program Lock system, when programmed, protects the on-chip program against software piracy.

Encryption Array Within the EPROM array are 64 bytes of encryption array that are initially unprogrammed (all FF's). Every time a byte is addressed during program verify, 6 address lines are used to select a byte of the encryption array. This byte is then exclusive-NOR'ed (XNOR) with the code byte, creating an encrypted verify byte. The algorithm, with the encryption array in the unprogrammed state, will return the code in its original, unmodified form.

When using the encryption array, one important factor needs to be considered. If a byte has the value FFh, verifying the byte will produce the encryption byte value. If a large block (>64 bytes) of code is left unprogrammed, a verification routine will display the content of the encryption array. For this reason all the unused code bytes should be programmed with random values. This will ensure program protection.

Program Lock Bits The three lock bits, when programmed according to Table 1., will provide different level of protection for the on-chip code and data.

Program Lock Bits				
Security level	LB1	LB2	LB3	Protection Description
1	U	U	U	No program lock features enabled. Code verify will still be encrypted by the encryption array if programmed. MOVC instruction executed from external program memory returns non encrypted data.
2	Ρ	U	U	MOVC instruction executed from external program memory are disabled from fetching code bytes from internal memory, \overline{EA} is sampled and latched on reset, and further programming of the EPROM is disabled.
3	U	Р	U	Same as 2, also verify is disabled.
4	U	U	Р	Same as 3, also external execution is disabled.

U: unprogrammed P: programmed

WARNING: Security level 2 and 3 should only be programmed after EPROM and Core verification.

Signature Bytes The TS80/87C52X2 contains 4 factory programmed signatures bytes. To read these bytes, perform the process described in section 9.

EPROM Programming

Set-up modes

In order to program and verify the EPROM or to read the signature bytes, the TS87C52X2 is placed in specific set-up modes (See Figure 11.).

TS8xCx2X2

Control and program signals must be held at the levels indicated in Table 35.

Definition of terms

Address Lines: P1.0-P1.7, P2.0-P2.4 respectively for A0-A12 Data Lines: P0.0-P0.7 for D0-D7 Control Signals: RST, PSEN, P2.6, P2.7, P3.3, P3.6, P3.7. Program Signals: ALE/PROG, EA/VPP.

Table 20. EPROM Set-up Modes

Mode	RST	PSEN	ALE/ PROG	EA/ VPP	P2.6	P2.7	P3.3	P3.6	P3.7
Program Code data	1	0	Ţ	12.75V	0	1	1	1	1
Verify Code data	1	0	1	1	0		0	1	1
Program Encryption Array Address 0-3Fh	1	0	U	12.75V	0	1	1	0	1
Read Signature Bytes	1	0	1	1	0	٦_ Г	0	0	0
Program Lock bit 1	1	0	ប	12.75V	1	1	1	1	1
Program Lock bit 2	1	0	Ъ	12.75V	1	1	1	0	0
Program Lock bit 3	1	0	Ъ	12.75V	1	0	1	1	0

Figure 11. Set-Up Modes Configuration



* See Table 31. for proper value on these inputs



Table 28., Table 31. and Table 34. give the frequency derating formula of the AC parameter. To calculate each AC symbols, take the x value corresponding to the speed grade you need (-M, -V or -L) and replace this value in the formula. Values of the frequency must be limited to the corresponding speed grade:

Table 25. Max frequency for derating formula regarding the speed grade

	-M X1 mode	-M X2 mode	-V X1 mode	-V X2 mode	-L X1 mode	-L X2 mode
Freq (MHz)	40	20	40	30	30	20
T (ns)	25	50	25	33.3	33.3	50

Example:

 T_{LLIV} in X2 mode for a -V part at 20 MHz (T = 1/20^{E6} = 50 ns):

```
x= 22 (Table 28.)
```

T= 50ns

T_{LLIV}= 2T - x = 2 x 50 - 22 = 78ns

External Program Memory Characteristics

Table 26. Symbol Description

Symbol	Parameter
Т	Oscillator clock period
T _{LHLL}	ALE pulse width
T _{AVLL}	Address Valid to ALE
T _{LLAX}	Address Hold After ALE
T _{LLIV}	ALE to Valid Instruction In
T _{LLPL}	ALE to PSEN
T _{PLPH}	PSEN Pulse Width
T _{PLIV}	PSEN to Valid Instruction In
T _{PXIX}	Input Instruction Hold After PSEN
T _{PXIZ}	Input Instruction FloatAfter PSEN
T _{PXAV}	PSEN to Address Valid
T _{AVIV}	Address to Valid Instruction In
T _{PLAZ}	PSEN Low to Address Float





Speed	-M 40 MHz		-V -V X2 mode standard 30 MHz mode 40 -M 60 MHz MHz 40 MHz equiv.		V dard le 40 Hz	-L X2 mode 20 MHz 40 MHz equiv.		-L standard mode 30 MHz		Units	
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Т	25		33		25		50		33		ns
T _{LHLL}	40		25		42		35		52		ns
T _{AVLL}	10		4		12		5		13		ns
T _{LLAX}	10		4		12		5		13		ns
T _{LLIV}		70		45		78		65		98	ns
T _{LLPL}	15		9		17		10		18		ns
T _{PLPH}	55		35		60		50		75		ns
T _{PLIV}		35		25		50		30		55	ns
T _{PXIX}	0		0		0		0		0		ns
T _{PXIZ}		18		12		20		10		18	ns
T _{AVIV}		85		53		95		80		122	ns
T _{PLAZ}		10		10		10		10		10	ns

Table 28. AC Parameters for a Variable Clock: derating formula

Symbol	Туре	Standard Clock	X2 Clock	-М	-V	-L	Units
T _{LHLL}	Min	2 T - x	T - x	10	8	15	ns
T _{AVLL}	Min	T - x	0.5 T - x	15	13	20	ns
T _{LLAX}	Min	T - x	0.5 T - x	15	13	20	ns
T _{LLIV}	Max	4 T - x	2 T - x	30	22	35	ns
T _{LLPL}	Min	T - x	0.5 T - x	10	8	15	ns
T _{PLPH}	Min	3 T - x	1.5 T - x	20	15	25	ns
T _{PLIV}	Max	3 T - x	1.5 T - x	40	25	45	ns
T _{PXIX}	Min	х	х	0	0	0	ns
T _{PXIZ}	Max	T - x	0.5 T - x	7	5	15	ns
T _{AVIV}	Max	5 T - x	2.5 T - x	40	30	45	ns
T _{PLAZ}	Max	x	x	10	10	10	ns

External Program Memory Read Cycle

Figure 18. External Program Memory Read Cycle



External Data Memory Characteristics

 Table 29.
 Symbol Description

Symbol	Parameter
T _{RLRH}	RD Pulse Width
T _{WLWH}	WR Pulse Width
T _{RLDV}	RD to Valid Data In
T _{RHDX}	Data Hold After RD
T _{RHDZ}	Data Float After RD
T _{LLDV}	ALE to Valid Data In
T _{AVDV}	Address to Valid Data In
T _{LLWL}	ALE to WR or RD
T _{AVWL}	Address to WR or RD
T _{QVWX}	Data Valid to WR Transition
T _{QVWH}	Data set-up to WR High
T _{WHQX}	Data Hold After WR
T _{RLAZ}	RD Low to Address Float
T _{WHLH}	RD or WR High to ALE high

External Data Memory Read Cycle

Figure 20. External Data Memory Read Cycle

Serial Port Timing - Shift Register Mode

Table 32. Symbol Description

Symbol	Parameter
T _{XLXL}	Serial port clock cycle time
T _{QVHX}	Output data set-up to clock rising edge
T _{XHQX}	Output data hold after clock rising edge
T _{XHDX}	Input data hold after clock rising edge
T _{XHDV}	Clock rising edge to input data valid

Table 33.	AC Parameters	for a Fix Clock
-----------	---------------	-----------------

Speed	-1 40 M	М ИНz	-\ X2 m 30 M 60 M equ	V node AHz AHz uiv.	ہ۔ stan mod Mi	V dard e 40 Hz	- X2 m 20 M 40 M equ	L node MHz MHz uiv.	- stan mo 30 M	L dard ode MHz	Units
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
T _{XLXL}	300		200		300		300		400		ns
T _{QVHX}	200		117		200		200		283		ns
T_{XHQX}	30		13		30		30		47		ns
T _{XHDX}	0		0		0		0		0		ns
T _{XHDV}		117		34		117		117		200	ns

External Clock Drive Characteristics (XTAL1)

Table 36. AC Parameters

Symbol	Parameter	Min	Мах	Units
T _{CLCL}	Oscillator Period	25		ns
Т _{снсх}	High Time	5		ns
T _{CLCX}	Low Time	5		ns
T _{CLCH}	Rise Time		5	ns
T _{CHCL}	Fall Time		5	ns
T _{CHCX} /T _{CLCX}	Cyclic ratio in X2 mode	40	60	%

External Clock Drive Waveforms

Figure 23. External Clock Drive Waveforms

AC Testing Input/Output Waveforms

Figure 24. AC Testing Input/Output Waveforms

INPUT/OUTPUT

AC inputs during testing are driven at V_{CC} - 0.5 for a logic "1" and 0.45V for a logic "0". Timing measurement are made at V_{IH} min for a logic "1" and V_{IL} max for a logic "0".

Float Waveforms

Figure 25. Float Waveforms

For timing purposes a port pin is no longer floating when a 100 mV change from load voltage occurs and begins to float when a 100 mV change from the loaded V_{OH}/V_{OL} level occurs. $I_{OL}/I_{OH} \ge \pm 20$ mA.

Ordering Information

Table 37. Possible Ordering Entries

Part Number ⁽³⁾	Memory Size	Supply Voltage	Temperature Range	Max Frequency	Package	Packing
TS80C32X2-MCA	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-MCB	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-MCC	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-MCE	ROMLess	5V <u>±</u> 10%	Commercial	40 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-LCA	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-LCB	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-LCC	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-LCE	ROMLess	2.7 to 5.5V	Commercial	30 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-VCA	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	PDIL40	Stick
TS80C32X2-VCB	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	PLCC44	Stick
TS80C32X2-VCC	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	PQFP44	Tray
TS80C32X2-VCE	ROMLess	5V <u>±</u> 10%	Commercial	60 MHz ⁽³⁾	VQFP44	Tray
TS80C32X2-MIA	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-MIB	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-MIC	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-MIE	ROMLess	5V <u>±</u> 10%	Industrial	40 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-LIA	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	PDIL40	Stick
TS80C32X2-LIB	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	PLCC44	Stick
TS80C32X2-LIC	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	PQFP44	Tray
TS80C32X2-LIE	ROMLess	2.7 to 5.5V	Industrial	30 MHz ⁽¹⁾	VQFP44	Tray
TS80C32X2-VIA	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	PDIL40	Stick
TS80C32X2-VIB	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	PLCC44	Stick
TS80C32X2-VIC	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	PQFP44	Tray
TS80C32X2-VIE	ROMLess	5V <u>±</u> 10%	Industrial	60 MHz ⁽³⁾	VQFP44	Tray
AT80C32X2-3CSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PDIL40	Stick
AT80C32X2-SLSUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	PLCC44	Stick
AT80C32X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	VQFP44	Tray
AT80C32X2-RLTUM	ROMLess	5V ±10%	Industrial & Green	40 MHz ⁽¹⁾	VQFP44	Tape & Reel
AT80C32X2-3CSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PDIL40	Stick
AT80C32X2-SLSUL	ROMLess	2.7 to 5.5V	Industrial & Green	30 MHz ⁽¹⁾	PLCC44	Stick

